

SKM600GA12E4



SEMITRANS® 4

IGBT4 Modules

SKM600GA12E4

Features

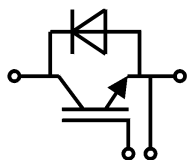
- IGBT4 = 4. Generation (Trench)IGBT
- V_{CEsat} with positive temperature coefficient
- High short circuit capability, self limiting to $6 \times I_{Cnom}$
- Soft switching 4. Generation CAL diode (CAL4)
- UL recognized, file no. E63532

Typical Applications*

- AC inverter drives
- UPS
- Electronic welders at f_{sw} up to 20 kHz

Remarks

- Case temperature limited to $T_c = 125^\circ\text{C}$ max, recomm. $T_{op} = -40 \dots +150^\circ\text{C}$, product rel. results valid for $T_j = 150^\circ$
- Short circuit: Soft Turn-off recommended $R_{Goff} > 20 \Omega$
- With $R_G = 2 \Omega$ the RBSOA is limited to $1 \times I_{Cnom} = 600 \text{ A}$



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Absolute Maximum Ratings				
Symbol	Conditions	Values	Unit	
IGBT				
V_{CES}	$T_j = 25^\circ\text{C}$	1200	V	
I_C	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	913	A
		$T_c = 80^\circ\text{C}$	702	A
I_{Cnom}		600	A	
I_{CRM}	$I_{CRM} = 3 \times I_{Cnom}$	1800	A	
V_{GES}		-20 ... 20	V	
t_{psc}	$V_{CC} = 800 \text{ V}$ $V_{GE} \leq 15 \text{ V}$ $V_{CES} \leq 1200 \text{ V}$	$T_j = 150^\circ\text{C}$	10	μs
T_j		-40 ... 175	$^\circ\text{C}$	
Inverse diode				
I_F	$T_j = 175^\circ\text{C}$	$T_c = 25^\circ\text{C}$	707	A
		$T_c = 80^\circ\text{C}$	529	A
I_{Fnom}		600	A	
I_{FRM}	$I_{FRM} = 3 \times I_{Fnom}$	1800	A	
I_{FSM}	$t_p = 10 \text{ ms, sin } 180^\circ, T_j = 25^\circ\text{C}$	3240	A	
T_j		-40 ... 175	$^\circ\text{C}$	
Module				
$I_{t(RMS)}$	$T_{terminal} = 80^\circ\text{C}$	500	A	
T_{stg}		-40 ... 125	$^\circ\text{C}$	
V_{isol}	AC sinus 50 Hz, $t = 1 \text{ min}$	4000	V	

Characteristics					
Symbol	Conditions	min.	typ.	max.	Unit
IGBT					
$V_{CE(sat)}$	$I_C = 600 \text{ A}$ $V_{GE} = 15 \text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	1.80	2.05	V
		$T_j = 150^\circ\text{C}$	2.20	2.40	V
V_{CE0}	chipelevel	$T_j = 25^\circ\text{C}$	0.8	0.9	V
		$T_j = 150^\circ\text{C}$	0.7	0.8	V
r_{CE}	$V_{GE} = 15 \text{ V}$ chipelevel	$T_j = 25^\circ\text{C}$	1.67	1.92	$\text{m}\Omega$
		$T_j = 150^\circ\text{C}$	2.50	2.67	$\text{m}\Omega$
$V_{GE(th)}$	$V_{GE} = V_{CE}, I_C = 24 \text{ mA}$	5	5.8	6.5	V
I_{CES}	$V_{GE} = 0 \text{ V}$ $V_{CE} = 1200 \text{ V}$	$T_j = 25^\circ\text{C}$	0.1	0.3	mA
		$T_j = 150^\circ\text{C}$			mA
C_{ies}	$V_{CE} = 25 \text{ V}$		37.2		nF
C_{oes}	$V_{GE} = 0 \text{ V}$		2.32		nF
C_{res}			2.04		nF
Q_G	$V_{GE} = -8 \text{ V} \dots +15 \text{ V}$		3400		nC
R_{Gint}	$T_j = 25^\circ\text{C}$		1.25		Ω
$t_{d(on)}$	$V_{CC} = 600 \text{ V}$ $I_C = 600 \text{ A}$	$T_j = 150^\circ\text{C}$	195		ns
t_r	$V_{GE} = \pm 15 \text{ V}$	$T_j = 150^\circ\text{C}$	90		ns
E_{on}	$R_{Gon} = 2 \Omega$	$T_j = 150^\circ\text{C}$	74		mJ
$t_{d(off)}$	$R_{Goff} = 2 \Omega$	$T_j = 150^\circ\text{C}$	690		ns
t_f	$di/dt_{on} = 6000 \text{ A}/\mu\text{s}$ $di/dt_{off} = 5200 \text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$	130		ns
E_{off}		$T_j = 150^\circ\text{C}$	84		mJ
$R_{th(j-c)}$	per IGBT			0.049	K/W



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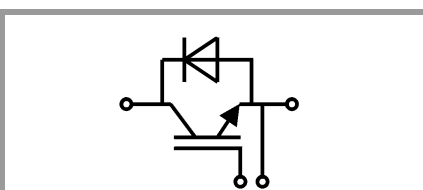
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- AC inverter drives
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- Short circuit: Soft Turn-off recommended $R_{Goff} > 20 \Omega$
- With $R_G = 2 \Omega$ the RBSOA is limited to $1 \times I_{Cnom} = 600 \text{ A}$

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
$V_F = V_{EC}$	$I_F = 600 \text{ A}$ $V_{GE} = 0 \text{ V}$ chiplevel	$T_j = 25^\circ\text{C}$		2.14	2.46	V
		$T_j = 150^\circ\text{C}$		2.07	2.38	V
V_{F0}	chiplevel	$T_j = 25^\circ\text{C}$		1.3	1.5	V
		$T_j = 150^\circ\text{C}$		0.9	1.1	V
r_F	chiplevel	$T_j = 25^\circ\text{C}$		1.4	1.6	m Ω
		$T_j = 150^\circ\text{C}$		1.9	2.1	m Ω
I_{RRM}	$I_F = 600 \text{ A}$	$T_j = 150^\circ\text{C}$		420		A
Q_{rr}	$di/dt_{off} = 5500 \text{ A}/\mu\text{s}$	$T_j = 150^\circ\text{C}$		92		μC
E_{rr}	$V_{GE} = \pm 15 \text{ V}$ $V_{CC} = 600 \text{ V}$	$T_j = 150^\circ\text{C}$		38		mJ
$R_{th(j-c)}$	per diode				0.086	K/W
Module						
L_{CE}				15	20	nH
$R_{CC'+EE'}$	terminal-chip	$T_c = 25^\circ\text{C}$		0.18		m Ω
		$T_c = 125^\circ\text{C}$		0.22		m Ω
$R_{th(c-s)}$	per module			0.02	0.038	K/W
M_s	to heat sink M6			3	5	Nm
M_t	to terminals	M6		2.5	5	Nm
		M4		1.1	2	Nm
w					330	g



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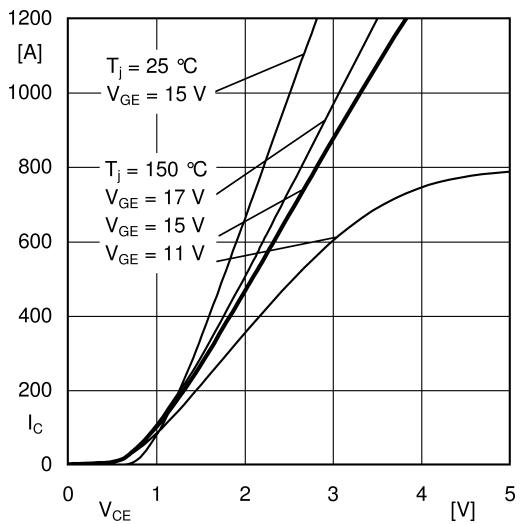


Fig. 1: Typ. output characteristic, inclusive $R_{CC'+EE'}$

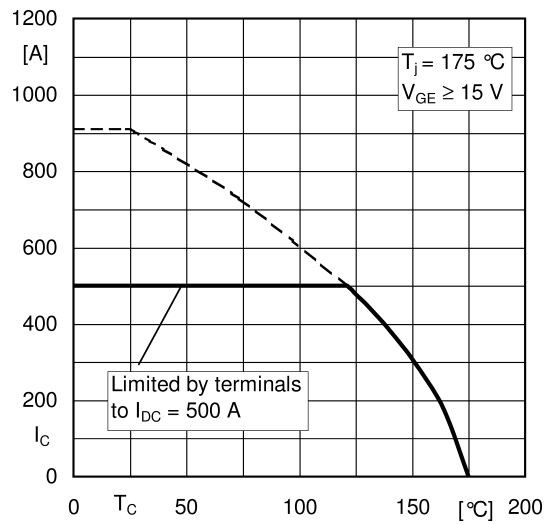


Fig. 2: Rated current vs. temperature $I_C = f(T_C)$

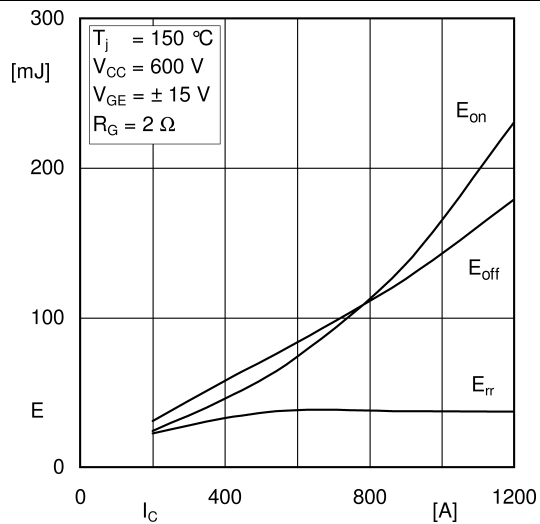


Fig. 3: Typ. turn-on /-off energy = $f(I_C)$

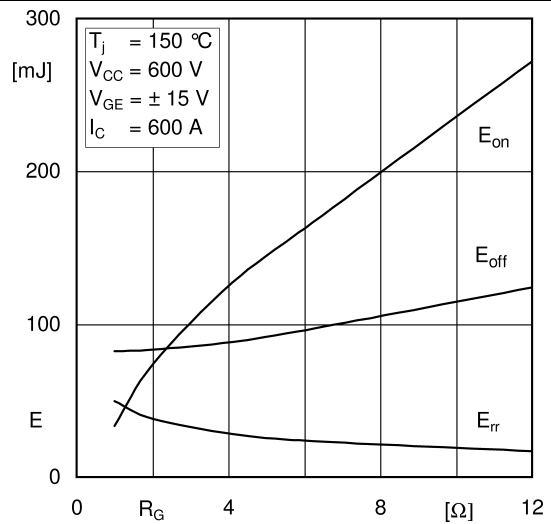


Fig. 4: Typ. turn-on /-off energy = $f(R_G)$

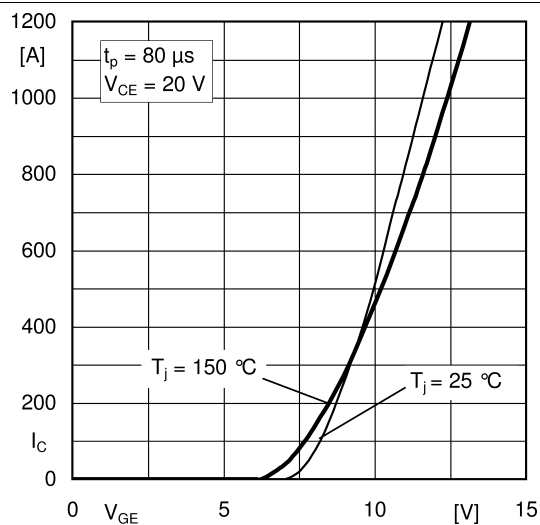


Fig. 5: Typ. transfer characteristic

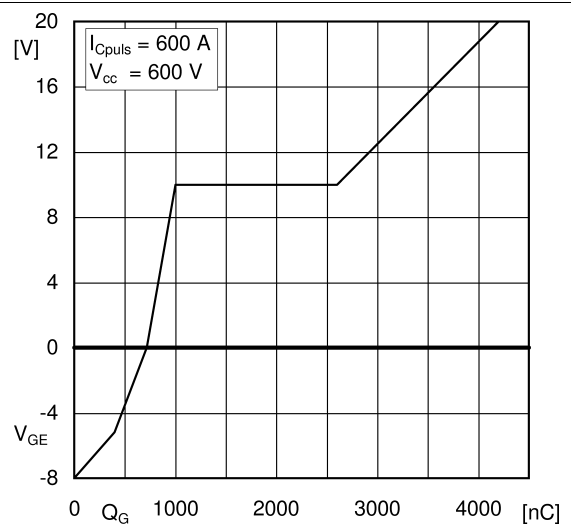


Fig. 6: Typ. gate charge characteristic

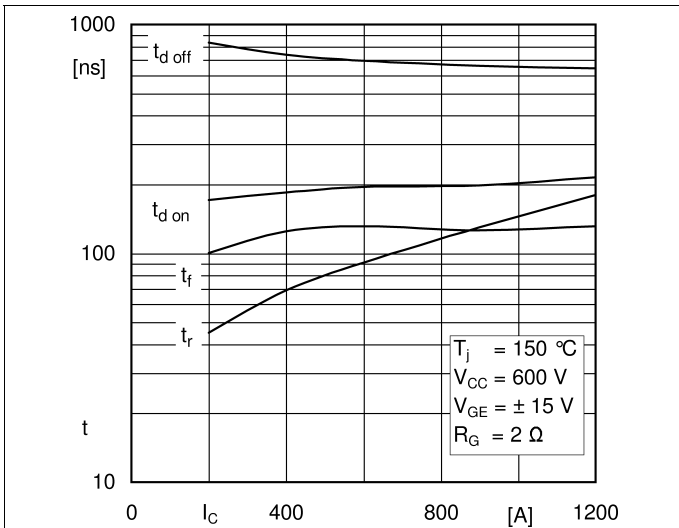


Fig. 7: Typ. switching times vs. I_C

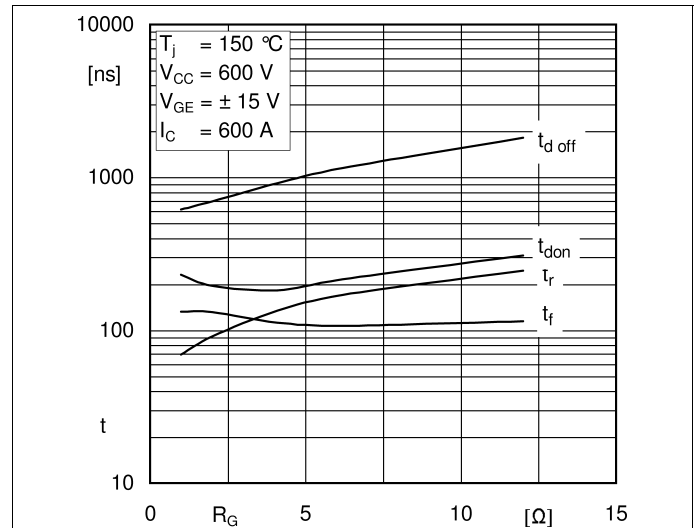


Fig. 8: Typ. switching times vs. gate resistor R_G

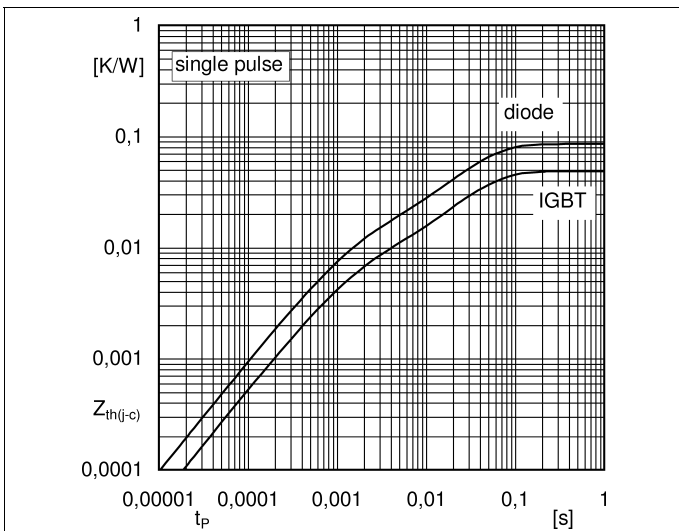


Fig. 9: Transient thermal impedance

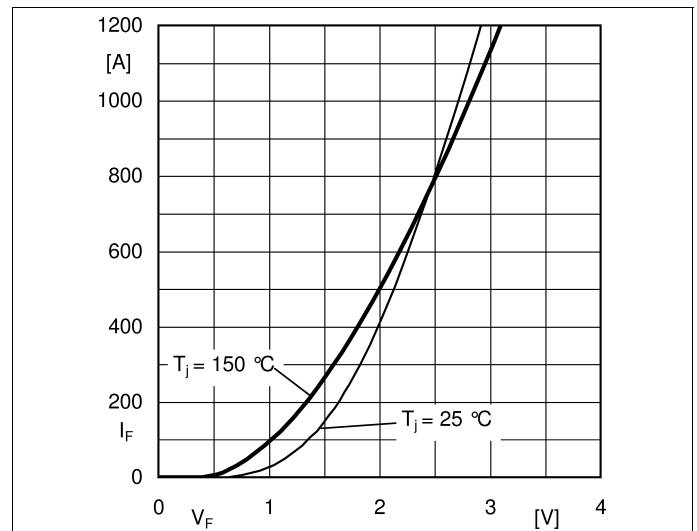


Fig. 10: Typ. CAL diode forward charact., incl. $R_{CC+EE'}$

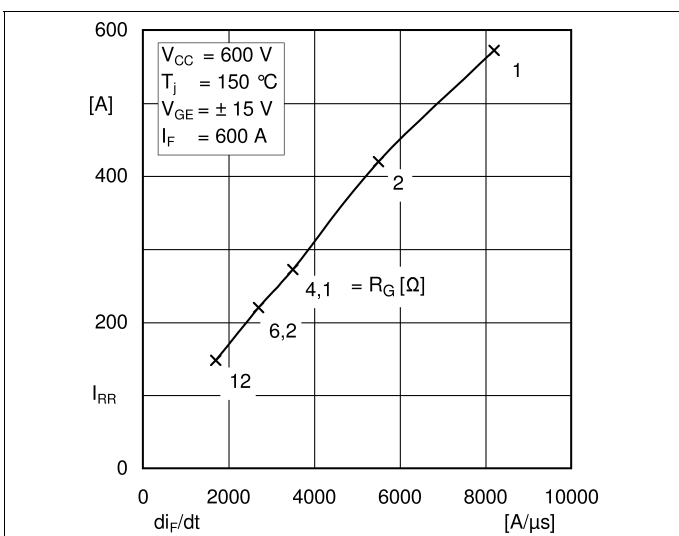


Fig. 11: CAL diode peak reverse recovery current

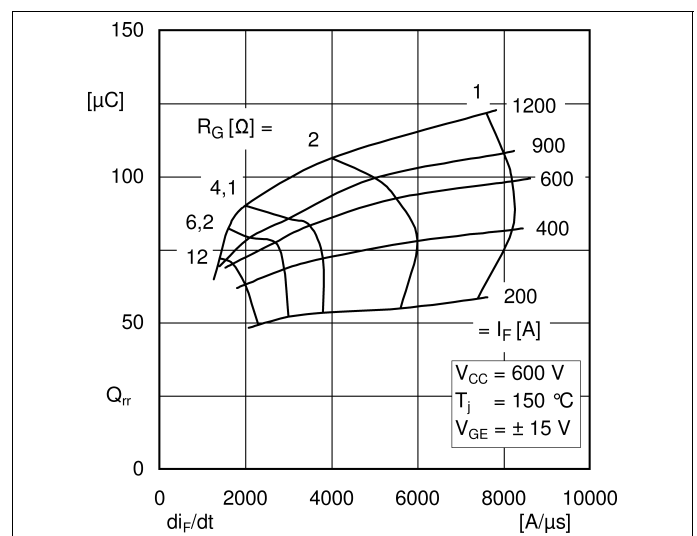
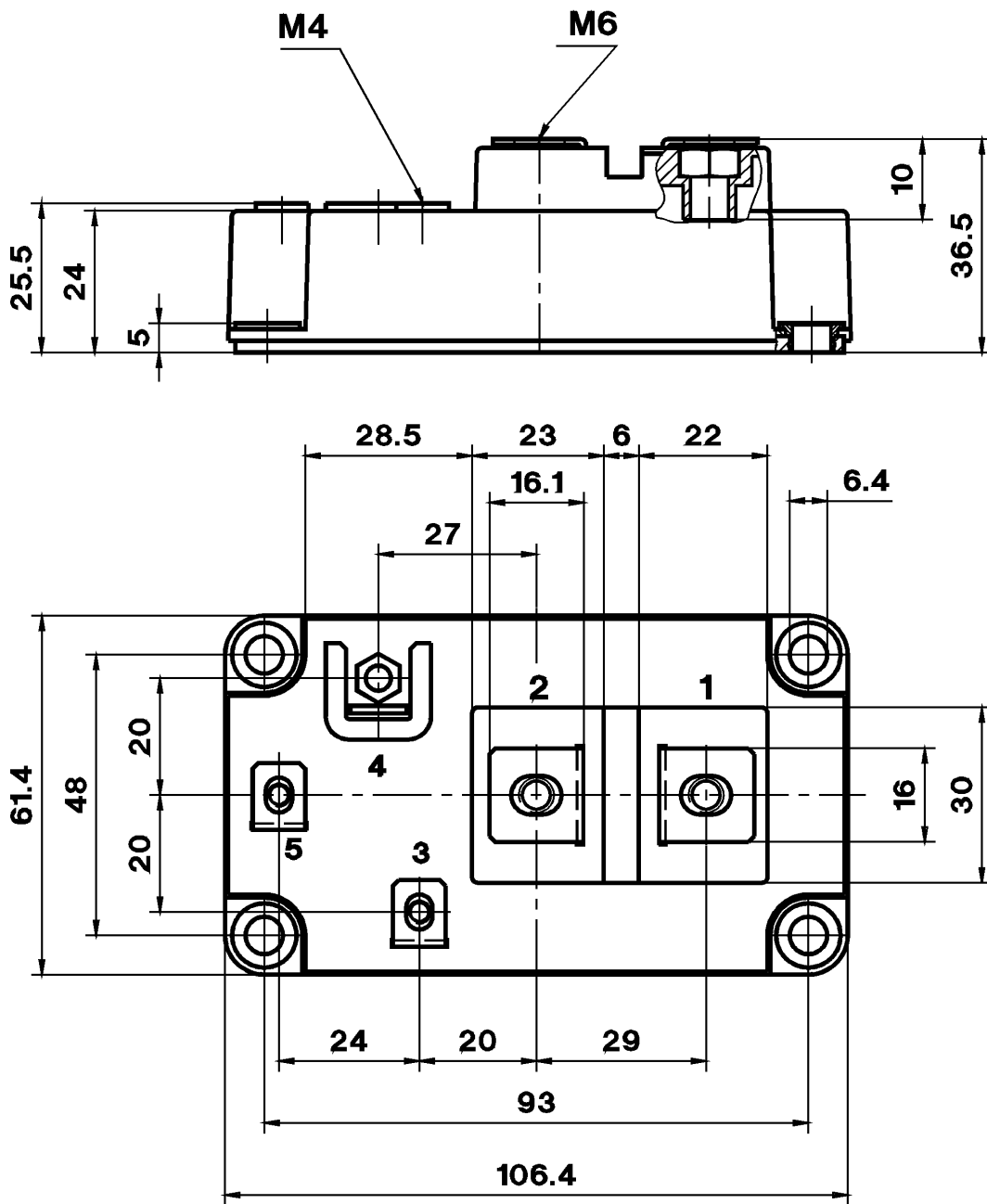
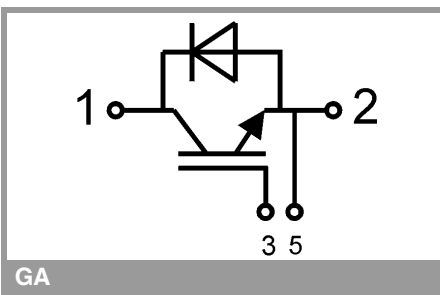


Fig. 12: Typ. CAL diode peak reverse recovery charge



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.